

# **UNISONIC TECHNOLOGIES CO., LTD**

## US3075-US3375

## POWER DISTRIBUTION SWITCH

### DESCRIPTION

The UTC **US3075-US3375** is a power distribution switch. It particularly designed for self-powered and bus-powered Universal Serial Bus (USB) applications.

The  $R_{DS(ON)}$  of the MOSFET switch is as low as  $100m\Omega$ .  $\overline{OC}$  is open-drain output report over-current or over-temperature event which has deglitch typical 9ms timeout period typically 9ms.

The UTC **US3075-US3375** incorporates protection circuits including current limiting circuit with foldback function, thermal shutdown circuit designed to prevent catastrophic switch failure due to increasing power dissipation when continuous heavy loads or short circuit occurs. Besides, a built-in charge pump is used to drive the N-channel MOSFET that is free of parasitic body diode to eliminate any reversed current flow across the switch when it is powered off.

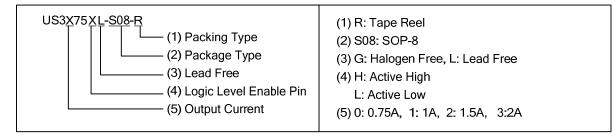
The UTC **US3075-US3375** is applied in high-side power protection switch, USB power management, USB host and self-powered bubs, USB bus-powered hubs, hot plug-in power supplies, battery-charger circuits.

### FEATURES

- \* Operating on The Range of 2.7V to 5.5V
- \* High-Side MOSFET with 100mΩ R<sub>DS(ON)</sub>
- \* Quiescent Supply Current: 65µA
- \* Available With 4 Versions of Current Limits with Foldback
- \* Rise Time: 400µS (TYP.)
- \* UVLO (Under Voltage Lockout)
- \* Output Shutdown Pull-low Resister
- \* Shutdown Supply Current: 1µA (MAX.)
- \* Logic Level Enable Pin, Available with Active-High or Active-Low Version
- \* Reverse Current is Not Generated when in Power Off State
- \* Deglitched Open-Drain Over-Current Flag Output ( OC )

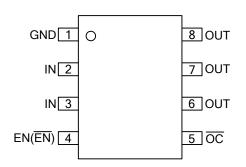
### ORDERING INFORMATION

Ordering	Dookogo	Deaking		
Lead Free	Halogen Free	Package	Packing	
US3075XL-S08-R	US3075XG-S08-R	SOP-8	Tape Reel	
US3175XL-S08-R	US3175XG-S08-R	SOP-8	Tape Reel	
US3275XL-S08-R	US3275XG-S08-R	SOP-8	Tape Reel	
US3375XL-S08-R	US3375XG-S08-R	SOP-8	Tape Reel	



SOP-8

### ■ PIN CONFIGURATION

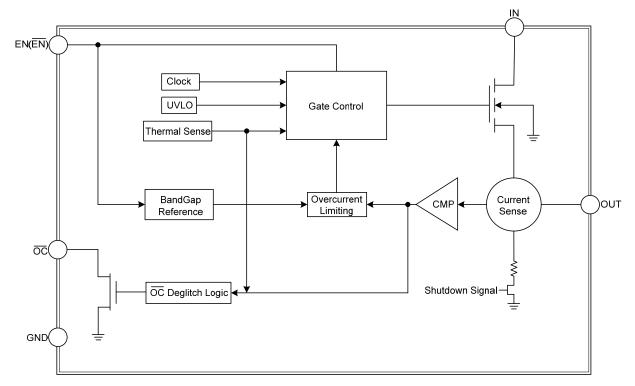


### PIN DESCRIPTION

PIN NO	PIN NAME	DESCRIPTION
1	GND	Ground
2,3	IN	Input Supply: Output MOSFET Drain, which also supplies IC's internal circuitry. Connect to positive supply.
4	EN(EN)	Enable: Logic level enable input. Make sure EN pin never floating.
5		Over-Current: Open-Drain OC output.
6,7,8	OUT	Switch Output: Output MOSFET Source of switch. Typically connect to switched side of load.



### BLOCK DIAGRAM





### ■ ABSOLUTE MAXIMUM RATING

PARAMETER	SYMBOL	RATINGS	UNIT
Supply Voltage	V <sub>IN</sub>	6	V
Output Voltage	V <sub>OUT</sub>	6	V
Output Current	I <sub>OUT</sub>	Internally Limited	А
Enable Input	V <sub>EN</sub>	-0.3 ~ 6	V
Storage Temperature	T <sub>STG</sub>	-65~ +150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

### OPERATING RATINGS

PARAMETER	SYMBOL	RATINGS	UNIT	
Supply Voltage	V <sub>IN</sub>	+3 ~ +5.5	V	
Ambient Operating Temperature	T <sub>OPR</sub>	-40~ +85	°C	

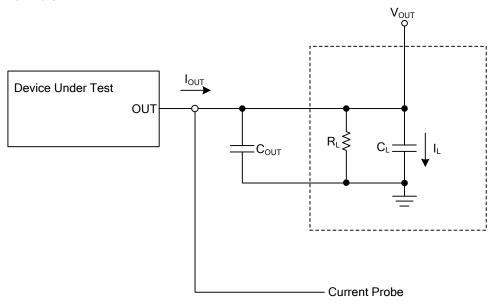
### ELECTRICAL CHARACTERISTICS

(V<sub>IN</sub>=5V, C<sub>IN</sub>=1 $\mu$ F, C<sub>OUT</sub>=1 $\mu$ F, R<sub>L</sub>=10 $\Omega$ , T<sub>A</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNIT
Input Voltage	V <sub>IN</sub>			2.7		5.5	V
Output MOS R <sub>DS(ON)</sub>		US3375, I <sub>OUT</sub> =1.5A US3275, I <sub>OUT</sub> =1A US3175, I <sub>OUT</sub> =0.5A US3075, I <sub>OUT</sub> =0.3A		-	100	115	mΩ
Supply Current	I <sub>IN</sub>				65		μA
Output Turn-on Rising Time		R <sub>L</sub> =10Ω, 90% Settling			400		μs
Current Limit Threshold	I <sub>THD(LIMIT)</sub>	US3075 US3175 US3275 US3375	V <sub>OUT</sub> =4V	0.5 0.7 1.1 1.5	0.75 1 1.5 2	1.4 1.7 2.1 2.8	A A A
Short-Circuit Current	I <sub>sc</sub>	US3075 US3175 US3275 US3375	V <sub>OUT</sub> =0V, 2.7V <v<sub>IN&lt;5.5 V</v<sub>	0.2 0.2 0.2 0.2	0.5 0.67 1 1.3	0.7 1 1.4 1.9	A A A
EN Input Threshold				1.3	1.6	1.8	V
Shutdown Supply Current	I <sub>SHDN</sub>				0.1	1	μA
Shutdown Pull Low Resistance					75	150	Ω
Output Leakage Current	I <sub>O(LEAK)</sub>	EN="0", V <sub>OUT</sub> =0V			0.5	1	μA
V <sub>IN</sub> Under Voltage Lockout				2.2	2.5	2.7	V
V <sub>IN</sub> Under Voltage Hysteresis					200		mV
Thermal Limit					135		°C
Thermal Limit Hysteresis					20		°C
OC Deglitch		OC assertio	on or deassertion	4	9	15	ms
OC Output Low Voltage		$I_{\overline{OC}} = 5mA$				0.4	V
OC Off-State Current		$V_{\overline{OC}} = 5V$				1	μA

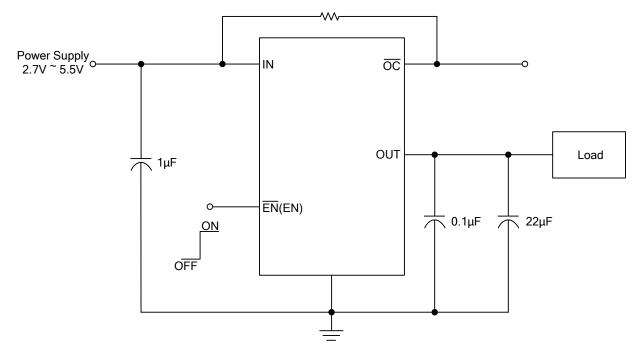


TEST CIRCUIT





#### **TYPICAL APPLICATION CIRCUIT**





### FUNCTIONAL DESCRIPTION

#### Input and Output

IN pin (Input) is the power supply connection to the logic circuitry and the drain of the output MOSFET. OUT pin (Output) is the source of the output MOSFET. In a typical application, current flows through the switch from input to output toward the load. Both OUT pins must be connected together to the load.

#### Thermal Shutdown

Thermal shutdown is designed to prevent this device from being damaged due to excessive power dissipation. It is used to turn off the output MOSFET when the if the temperature is higher than135°C, 20°C of hysteresis prevents the switch turn on until the die temperature drops to 115°C. Thermal shutdown circuit functions only when the switch is enabled.

#### Under Voltage Lockout

UVLO (Under voltage Lockout) turns off the MOSFET switch once the input voltage falls below 2.3V (TYP.) and if the input voltage exceeds 2.5V (TYP.), the switch will be turned on. UVLO detection functions only when the switch is enabled.

#### **Current Limiting**

The current limit value is fixed internally, typically 2A, 1.5A, 1A, 0.75A for **US3375/ US3275/ US3175/ US3075** respectively. There is foldback of current limit When  $V_{OUT}$  is less than 1.5V, there is foldback of current limit. **OC Function** 

The  $\overline{OC}$  open-drain output is asserted (active low) when an over current or over temperature shutdown condition is encountered after a 9-ms deglitch timeout. The output keeps asserted until the over current or over temperature condition is removed.

### APPLICATION INFORMATION

#### Supply Filtering

To avoid supply transients, 1µF bypass capacitor is strongly recommended to located between IN to GND. Without a bypass capacitor, an output short may cause sufficient ringing on the input (from supply lead inductance) to damage internal control circuitry.

Input transients value must be not higher than the absolute maximum supply voltage ( $V_{IN max} = 6V$ ) even for a short duration.

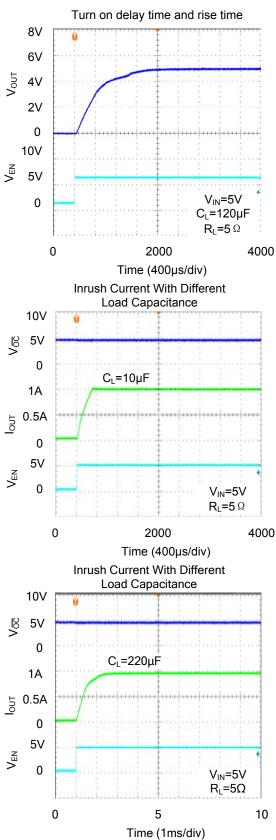
#### EN, the Enable Input

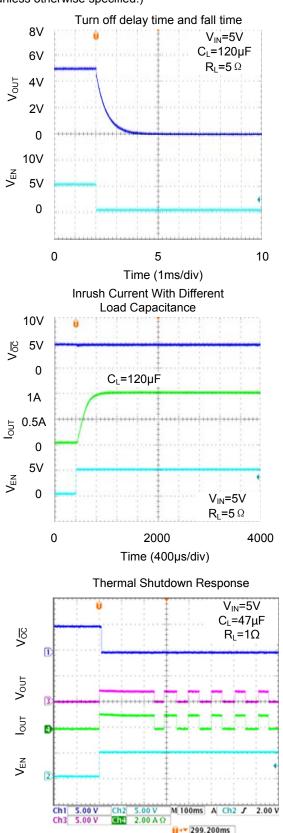
The enable pin, EN, must be driven logic high or logic low for a clearly defined input. The input is not allowed to float, or unpredictable operation may be occurs. EN should not be allowed to go negative with respect to GND.



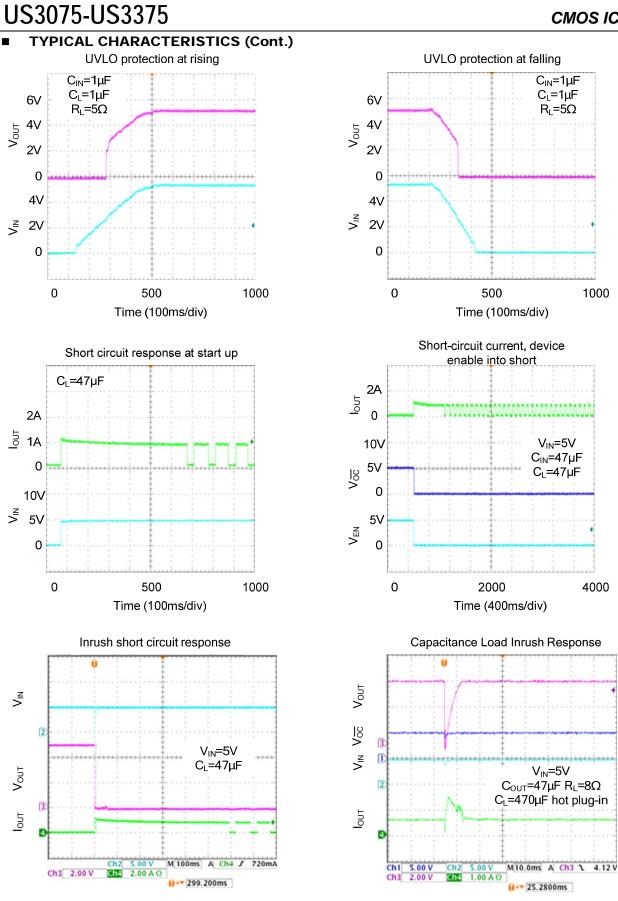


(V<sub>IN</sub>= 5V, 3275H, C<sub>IN</sub>=1 $\mu$ F, C<sub>OUT</sub>=1 $\mu$ F, V<sub>EN</sub>=0V, T<sub>A</sub>=25°C, unless otherwise specified.)







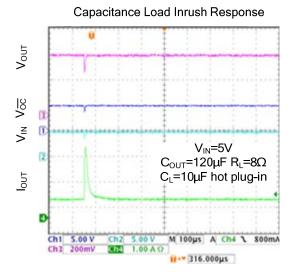




### CMOS IC

## US3075-US3375

### TYPICAL CHARACTERISTICS (Cont.)



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